Nuvoton Technology Corporation - NUC140VE3CN Datasheet

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Last Time Buy
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	CANbus, EBI/EMI, I²C, IrDA, LINbus, SPI, UART/USART, USB
Peripherals	Brown-out Detect/Reset, DMA, I²S, POR, PWM, WDT
Number of I/O	76
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/nuvoton-technology-corporation-america/nuc140ve3cn

Contents

Figures

Tables

- Timer
  - Support 4 sets of 32-bit timers with 24-bit up-timer and one 8-bit pre-scale counter
  - Independent clock source for each timer
  - Provides one-shot, periodic, toggle and continuous counting operation modes
  - Support event counting function
  - Support input capture function
- Watchdog Timer
  - Multiple clock sources
  - 8 selectable time out period from 1.6ms ~ 26.0sec (depends on clock source)
  - WDT can wake-up from power down or idle mode
  - Interrupt or reset selectable on watchdog time-out
- RTC
  - Support software compensation by setting frequency compensate register (FCR)
  - Support RTC counter (second, minute, hour) and calendar counter (day, month, year)
  - Support Alarm registers (second, minute, hour, day, month, year)
  - Selectable 12-hour or 24-hour mode
  - Automatic leap year recognition
  - Support periodic time tick interrupt with 8 period options 1/128, 1/64, 1/32, 1/16, 1/8, 1/4, 1/2 and 1 second
  - Support wake-up function
- PWM/Capture
  - Built-in up to four 16-bit PWM generators provide eight PWM outputs or four complementary paired PWM outputs
  - Each PWM generator equipped with one clock source selector, one clock divider, one 8-bit prescaler and one Dead-Zone generator for complementary paired PWM
  - Up to eight 16-bit digital Capture timers (shared with PWM timers) provide eight rising/falling capture inputs
  - Support Capture interrupt
- UART
  - Up to three UART controllers
  - UART ports with flow control (TXD, RXD, CTS and RTS)
  - UART0 with 64-byte FIFO is for high speed
  - UART1/2(optional) with 16-byte FIFO for standard device
  - Support IrDA (SIR) and LIN function
  - Support RS-485 9-bit mode and direction control.
  - Programmable baud-rate generator up to 1/16 system clock
  - Support PDMA mode
- SPI
  - Up to four sets of SPI controller
  - Master up to 32 MHz, and Slave up to 10 MHz (chip working @ 5V)
  - Support SPI master/slave mode
  - Full duplex synchronous serial data transfer
  - Variable length of transfer data from 1 to 32 bits
  - MSB or LSB first data transfer
  - Rx and Tx on both rising or falling edge of serial clock independently
  - 2 slave/device select lines when it is as the master, and 1 slave/device select line when it is as the slave
  - Support byte suspend mode in 32-bit transmission
  - Support PDMA mode
  - Support three wire, no slave select signal, bi-direction interface

3 PARTS INFORMATION LIST AND PIN CONFIGURATION

3.1 NuMicro™ NUC140 Products Selection Guide

3.1.1 NuMicro™ NUC140 Connectivity Line Selection Guide

Part number	APROM	RAM	Data Flash	ISP Loader ROM	I/O	Timer	Connectivity						I^2S	Comp.	PWM	ADC	RTC	EBI	ISP ICP	Package
							UART	SPI	I^2C	USB	LIN	CAN								
NUC140LC1CN	32 KB	4 KB	4 KB	4 KB	up to 31	4x32-bit	2	1	2	1	2	1	1	1	4	8x12-bit	v	-	v	LQFP48
NUC140LD2CN	64 KB	8 KB	4 KB	4 KB	up to 31	4x32-bit	2	1	2	1	2	1	1	1	4	8x12-bit	v	-	v	LQFP48
NUC140LE3CN	128 KB	16 KB	Definable	4 KB	up to 31	4x32-bit	2	1	2	1	2	1	1	1	4	8x12-bit	v	-	v	LQFP48
NUC140RC1CN	32 KB	4 KB	4 KB	4 KB	up to 45	4x32-bit	3	2	2	1	2	1	1	2	4	8x12-bit	v	v	v	LQFP64
NUC140RD2CN	64 KB	8 KB	4 KB	4 KB	up to 45	4x32-bit	3	2	2	1	2	1	1	2	4	8x12-bit	v	v	v	LQFP64
NUC140RE3CN	128 KB	16 KB	Definable	4 KB	up to 45	4x32-bit	3	2	2	1	2	1	1	2	4	8x12-bit	v	v	v	LQFP64
NUC140VE3CN	128 KB	16 KB	Definable	4 KB	up to 76	4x32-bit	3	4	2	1	2	1	1	2	8	8x12-bit	v	v	v	LQFP100

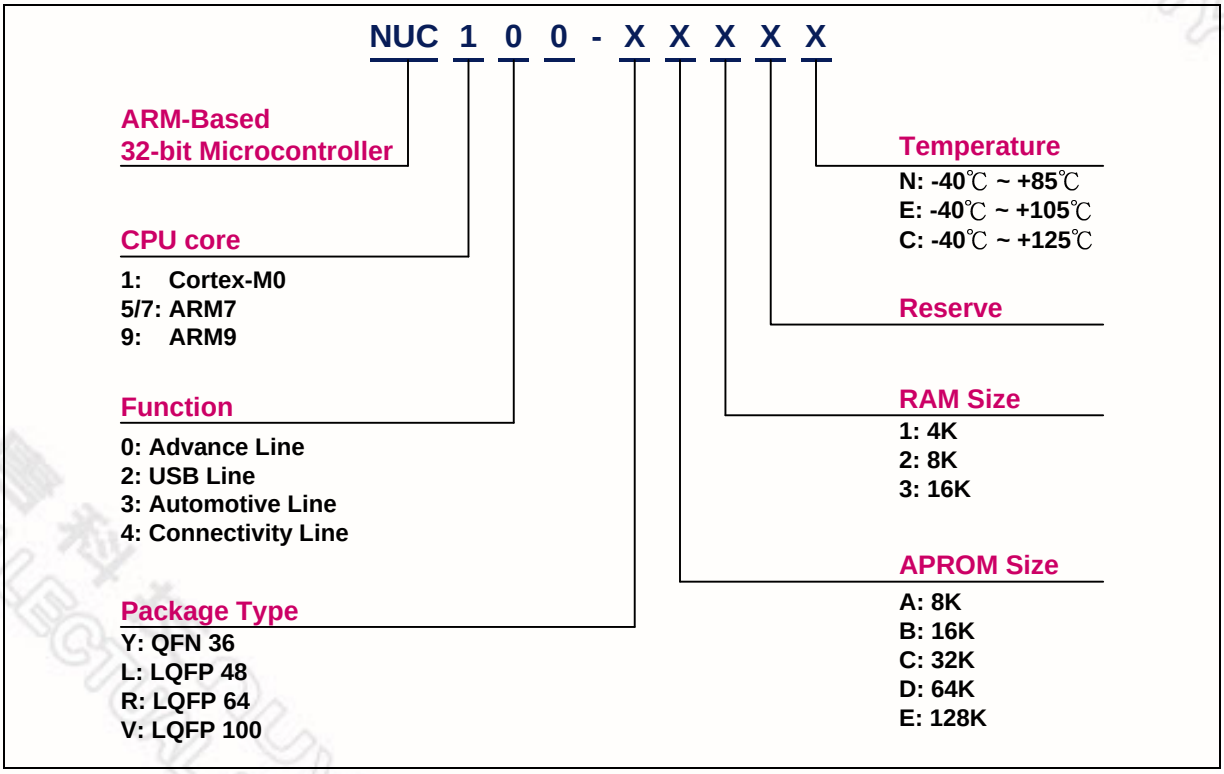


Figure 3-1 NuMicro™ NUC100 Series selection code

4 BLOCK DIAGRAM

4.1 NuMicro™NUC140 Block Diagram

4.1.1 NuMicro™ NUC140 Block Diagram

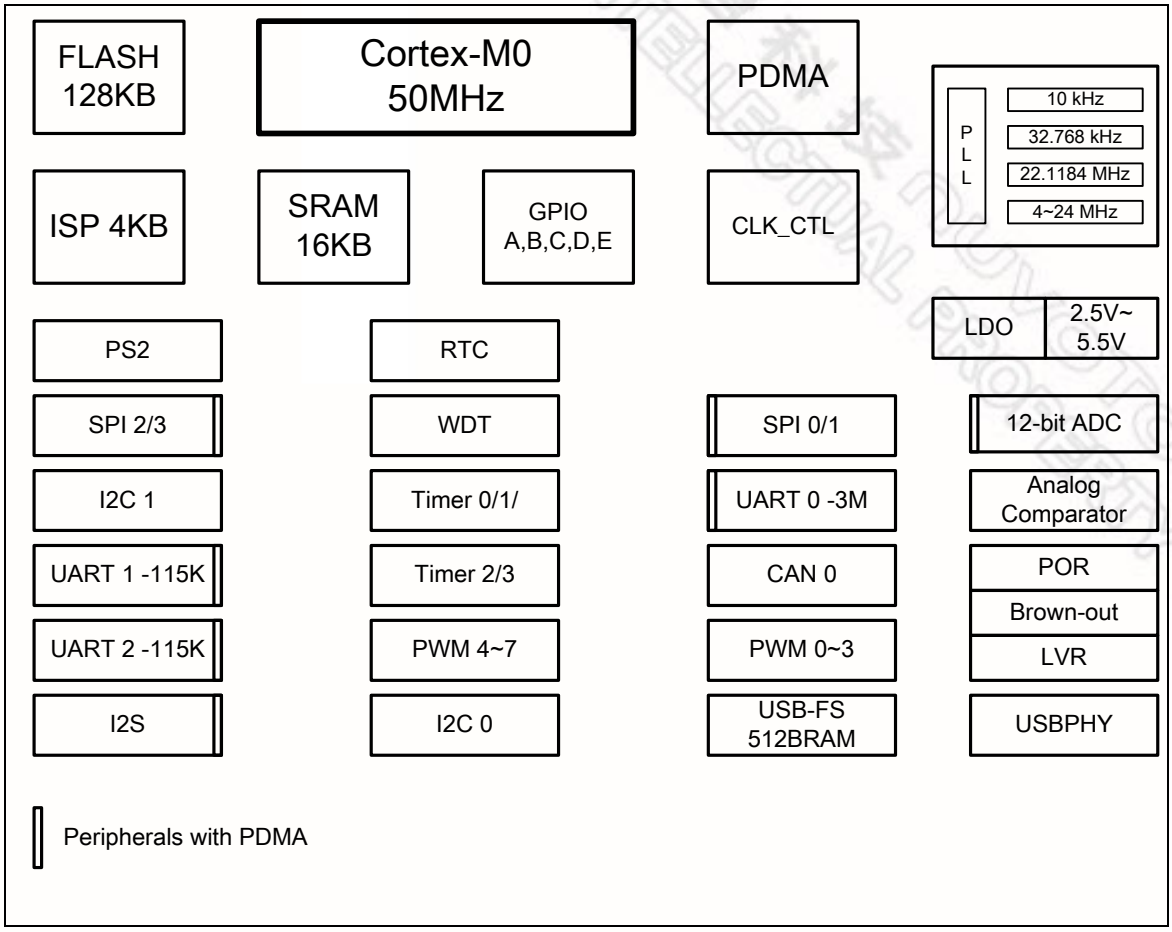


Figure 4-1 NuMicro™ NUC140 Block Diagram

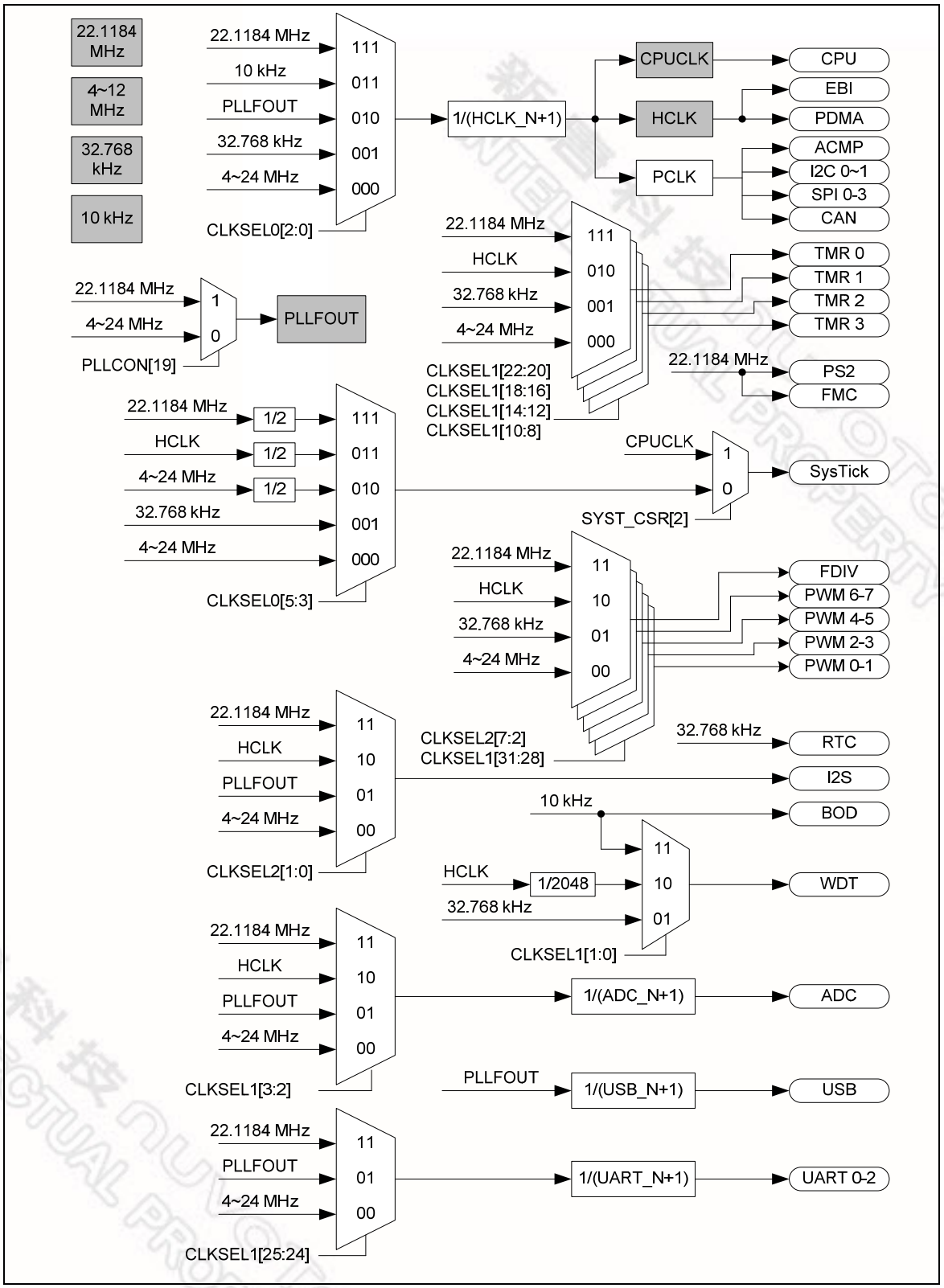


Figure 5-3 Clock generator global view diagram

5.3.3 System Clock and SysTick Clock

The system clock has 5 clock sources which were generated from clock generator block. The clock source switch depends on the register HCLK_S (CLKSEL0[2:0]). The block diagram is showed in Figure 5-5.

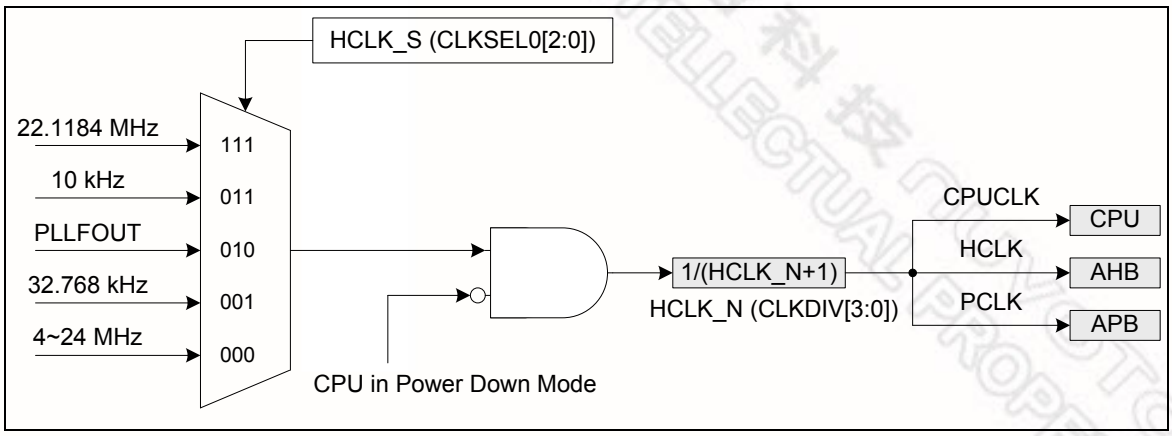


Figure 5-5 System Clock Block Diagram

The clock source of SysTick in Cortex-M0 core can use CPU clock or external clock (SYST_CSR[2]). If using external clock, the SysTick clock (STCLK) has 5 clock sources. The clock source switch depends on the setting of the register STCLK_S (CLKSEL0[5:3]). The block diagram is showed in Figure 5-6.

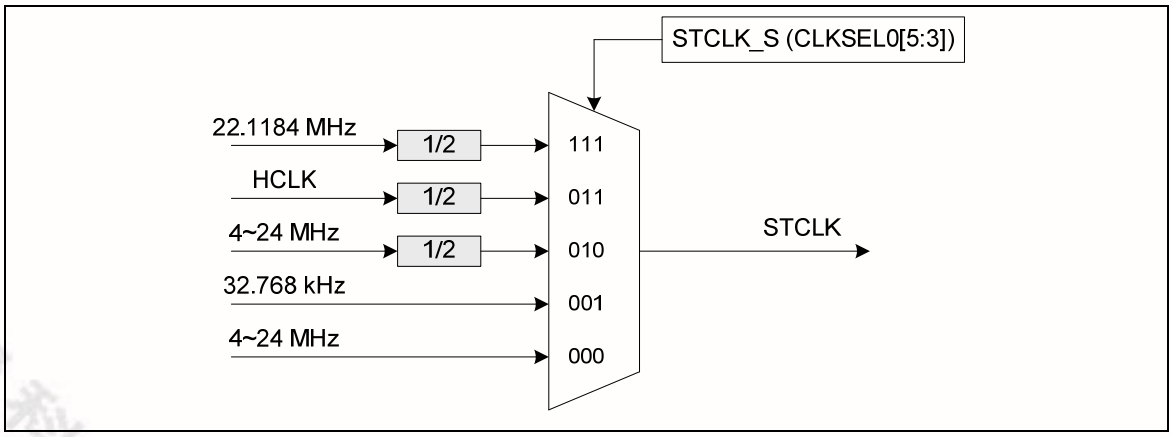


Figure 5-6 SysTick Clock Control Block Diagram

5.5 General Purpose I/O (GPIO)

5.5.1 Overview

NuMicro™ NUC130/NUC140 has up to 80 General Purpose I/O pins can be shared with other function pins; it depends on the chip configuration. These 80 pins are arranged in 5 ports named with GPIOA, GPIOB, GPIOC, GPIOD and GPIOE. Each port equips maximum 16 pins. Each one of the 80 pins is independent and has the corresponding register bits to control the pin mode function and data.

The I/O type of each of I/O pins can be configured by software individually as input, output, open-drain or quasi-bidirectional mode. After reset, the I/O type of all pins stay in quasi-bidirectional mode and port data register GPIOx_DOUT[15:0] resets to 0x0000_FFFF. Each I/O pin equips a very weakly individual pull-up resistor which is about 110 KΩ~300 KΩ for V_{DD} is from 5.0 V to 2.5 V.

5.5.2 Features

- Four I/O modes:
  - Quasi bi-direction
  - Push-Pull output
  - Open-Drain output
  - Input only with high impendence
- TTL/Schmitt trigger input selectable
- I/O pin can be configured as interrupt source with edge/level setting
- High driver and high sink IO mode support

5.6 I²C Serial Interface Controller (Master/Slave) (I²C)

5.6.1 Overview

I²C is a two-wire, bi-directional serial bus that provides a simple and efficient method of data exchange between devices. The I²C standard is a true multi-master bus including collision detection and arbitration that prevents data corruption if two or more masters attempt to control the bus simultaneously.

Data is transferred between a Master and a Slave synchronously to SCL on the SDA line on a byte-by-byte basis. Each data byte is 8-bit long. There is one SCL clock pulse for each data bit with the MSB being transmitted first. An acknowledge bit follows each transferred byte. Each bit is sampled during the high period of SCL; therefore, the SDA line may be changed only during the low period of SCL and must be held stable during the high period of SCL. A transition on the SDA line while SCL is high is interpreted as a command (START or STOP). Please refer to the Figure 5-9 for more detail I²C BUS Timing.

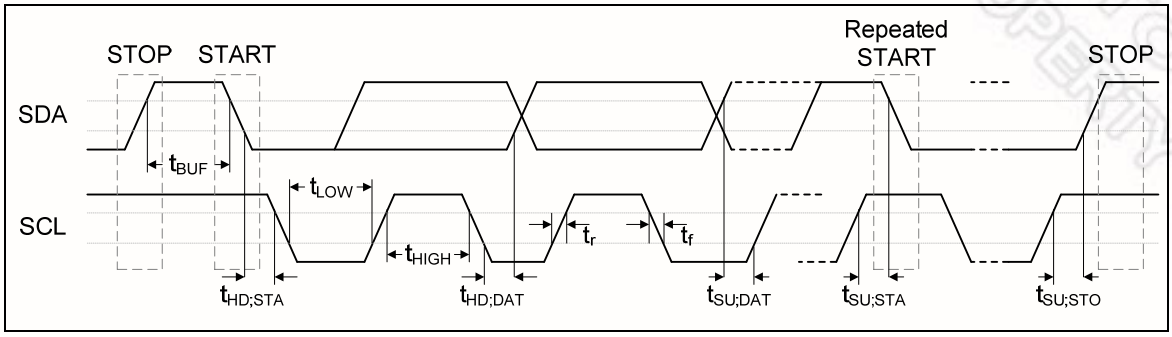


Figure 5-9 I²C Bus Timing

The device's on-chip I²C logic provides the serial interface that meets the I²C bus standard mode specification. The I²C port handles byte transfers autonomously. To enable this port, the bit ENS1 in I2CON should be set to '1'. The I²C H/W interfaces to the I²C bus via two pins: SDA and SCL. Pull up resistor is needed for I²C operation as these are open drain pins. When the I/O pins are used as I²C port, user must set the pins function to I²C in advance.

WTIS	Timeout Interval Selection T_{TIS}	Interrupt Period T_{INT}	WTR Timeout startingInterval (WDT_CLK=10 kHz) MIN. T_{WTR} ~ Max. T_{WTR}
000	$2^4 * T_{WDT}$	1024 * T_{WDT}	1.6 ms ~ 104 ms
001	$2^6 * T_{WDT}$	1024 * T_{WDT}	6.4 ms ~ 108.8 ms
010	$2^8 * T_{WDT}$	1024 * T_{WDT}	25.6 ms ~ 128 ms
011	$2^{10} * T_{WDT}$	1024 * T_{WDT}	102.4 ms ~ 204.8 ms
100	$2^{12} * T_{WDT}$	1024 * T_{WDT}	409.6 ms ~ 512 ms
101	$2^{14} * T_{WDT}$	1024 * T_{WDT}	1.6384 s ~ 1.7408 s
110	$2^{16} * T_{WDT}$	1024 * T_{WDT}	6.5536 s ~ 6.656 s
111	$2^{18} * T_{WDT}$	1024 * T_{WDT}	26.2144 s ~ 26.3168 s

Table 5-5 Watchdog Timeout Interval Selection

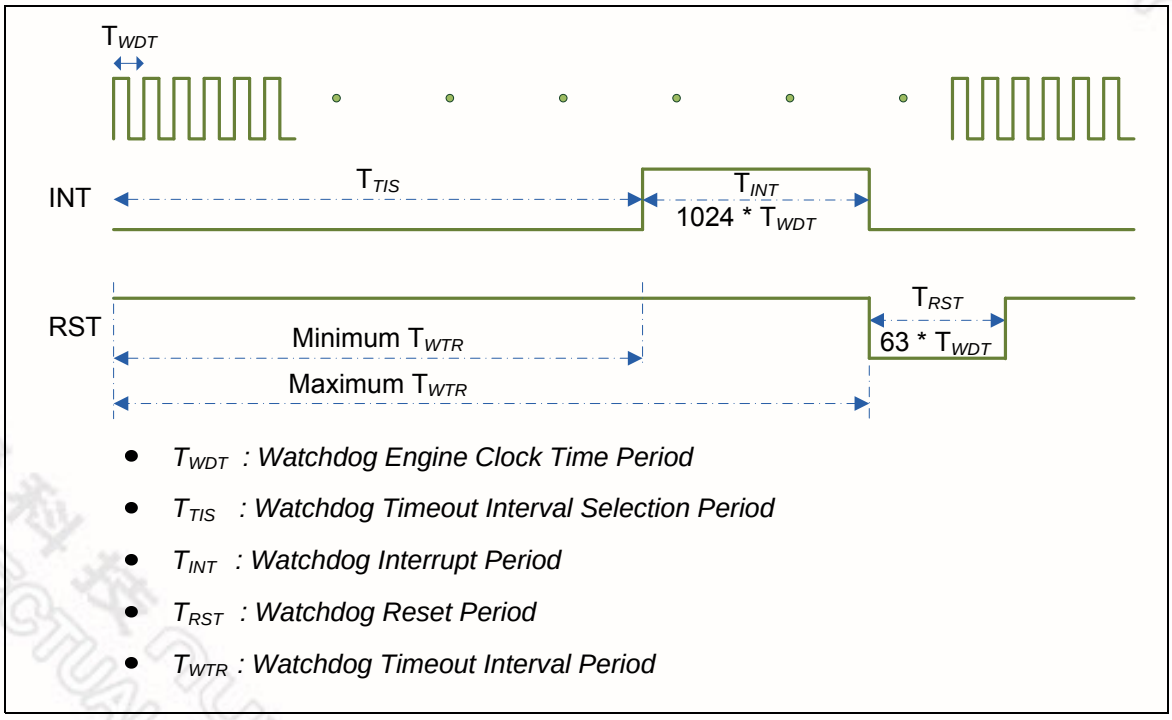


Figure 5-10 Timing of Interrupt and Reset Signal

5.16 Analog-to-Digital Converter (ADC)

5.16.1 Overview

NuMicro™ NUC100 Series contains one 12-bit successive approximation analog-to-digital converters (SAR A/D converter) with 8 input channels. The A/D converter supports three operation modes: single, single-cycle scan and continuous scan mode. The A/D converters can be started by software and external STADC pin.

5.16.2 Features

- Analog input voltage range: 0~V_{REF}
- 12-bit resolution and 10-bit accuracy is guaranteed
- Up to 8 single-end analog input channels or 4 differential analog input channels
- Maximum ADC clock frequency is 16 MHz
- Up to 700K SPS conversion rate
- Three operating modes
  - Single mode: A/D conversion is performed one time on a specified channel
  - Single-cycle scan mode: A/D conversion is performed one cycle on all specified channels with the sequence from the lowest numbered channel to the highest numbered channel
  - Continuous scan mode: A/D converter continuously performs Single-cycle scan mode until software stops A/D conversion
- An A/D conversion can be started by
  - Software write 1 to ADST bit
  - External pin STADC
- Conversion results are held in data registers for each channel with valid and overrun indicators
- Conversion result can be compared with specify value and user can select whether to generate an interrupt when conversion result is equal to the compare register setting
- Channel 7 supports 3 input sources: external analog voltage, internal bandgap voltage, and internal temperature sensor output
- Support Self-calibration to minimize conversion error

5.17 Analog Comparator (CMP)

5.17.1 Overview

NuMicro™ NUC100 Series contains two comparators. The comparators can be used in a number of different configurations. The comparator output is a logical one when positive input greater than negative input, otherwise the output is a zero. Each comparator can be configured to cause an interrupt when the comparator output value changes. The block diagram is shown in **Error! Reference source not found.**.

5.17.2 Features

- Analog input voltage range: 0~5.0 V
- Hysteresis function supported
- Two analog comparators with optional internal reference voltage input at negative end
- One interrupt vector for both comparators

PARAMETER	SYM.	SPECIFICATION				TEST CONDITIONS
		MIN.	TYP.	MAX.	UNIT	
Bandgap voltage	V_{BG}	1.20	1.26	1.32	V	V_{DD} = 2.5 V~5.5 V

Note:

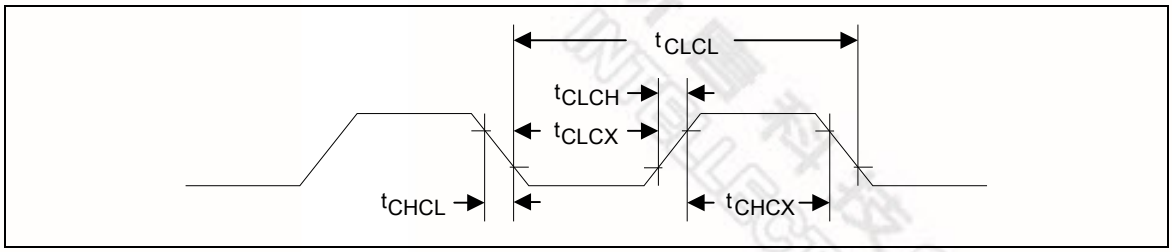
1. /RESET pin is a Schmitt trigger input.

2. Crystal Input is a CMOS input.

3. Pins of PA, PB, PC, PD and PE can source a transition current when they are being externally driven from 1 to 0. In the condition of V_{DD}=5.5 V, 5he transition current reaches its maximum value when V_{IN} approximates to 2 V.

7.3 AC Electrical Characteristics

7.3.1 External 4~24 MHz High Speed Oscillator



Note: Duty cycle is 50%.

SYMBOL	PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
t_{CHCX}	Clock High Time		20	-	-	nS
t_{CLCX}	Clock Low Time		20	-	-	nS
t_{CLCH}	Clock Rise Time		-	-	10	nS
t_{CHCL}	Clock Fall Time		-	-	10	nS

7.3.2 External 4~24 MHz High Speed Crystal

PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Input clock frequency	External crystal	4	12	24	MHz
Temperature	-	-40	-	85	℃
V_{DD}	-	2.5	5	5.5	V
Operating current	12 MHz@ V_{DD} = 5V	-	1	-	mA

7.3.2.1 Typical Crystal Application Circuits

CRYSTAL	C1	C2	R
4 MHz ~ 24 MHz	without	without	without

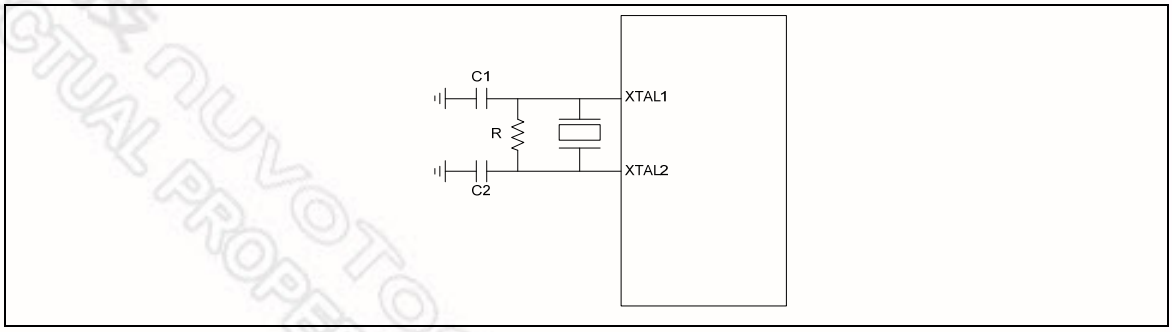


Figure 7-1 Typical Crystal Application Circuit

7.3.3 External 32.768 kHz Low Speed Crystal

PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Input clock frequency	External crystal	-	32.768	-	kHz
Temperature	-	-40	-	85	℃
V_{DD}	-	2.5	-	5.5	V

7.3.4 Internal 22.1184 MHz High Speed Oscillator

PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply voltage[1]	-	2.5	-	5.5	V
Center Frequency	-	-	22.1184	-	MHz
Calibrated Internal Oscillator Frequency	+25℃; V_{DD} =5 V	-1	-	+1	%
	-40℃~+85℃; V_{DD}=2.5 V~5.5 V	-3	-	+3	%
Operation Current	V_{DD} =5 V	-	500	-	uA

7.3.5 Internal 10 kHz Low Speed Oscillator

PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply voltage[1]	-	2.5	-	5.5	V
Center Frequency	-	-	10	-	kHz
Calibrated Internal Oscillator Frequency	+25℃; V_{DD} =5 V	-30	-	+30	%
	-40℃~+85℃; V_{DD}=2.5 V~5.5 V	-50	-	+50	%

Note: Internal operation voltage comes from LDO.

7.4.2 Specification of LDO and Power management

PARAMETER	MIN.	TYP.	MAX.	UNIT	NOTE
Input Voltage	2.7	5	5.5	V	V_{DD} input voltage
Output Voltage	-10%	2.5	+10%	V	V_{DD} > 2.7 V
Temperature	-40	25	85	℃	
Cbp	-	1	-	uF	Resr=1ohm

Note:

1. It is recommended that a 10uF or higher capacitor and a 100nF bypass capacitor are connected between V_{DD} and the closest V_{SS} pin of the device.

2. For ensuring power stability, a 1uF or higher capacitor must be connected between LDO pin and the closest V_{SS} pin of the device.

7.4.6 Specification of Temperature Sensor

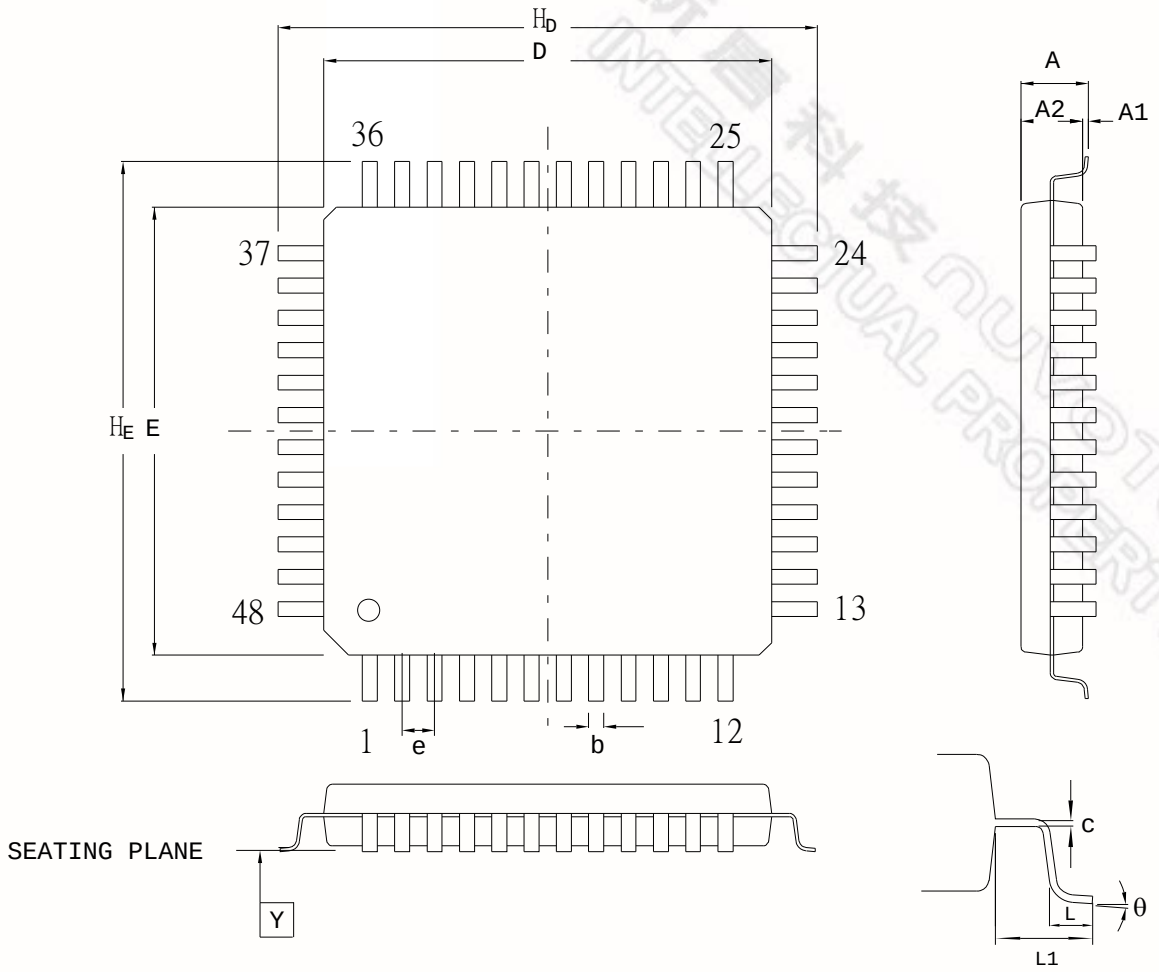
PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply voltage[1]		2.5	-	5.5	V
Temperature		-40	-	125	℃
Current consumption		6.4	-	10.5	uA
Gain			-1.76		mV/℃
Offset	Temp=0 ℃		720		mV

Note: Internal operation voltage comes from LDO.

7.4.7 Specification of Comparator

PARAMETER	CONDITION	MIN.	TYP.	MAX.	UNIT
Temperature	-	-40	25	85	℃
V_{DD}	-	2.4	3	5.5	V
V_{DD} current	20 uA@V_{DD}=3 V	-	20	40	uA
Input offset voltage	-	-	5	15	mV
Output swing	-	0.1	-	V_{DD}-0.1	V
Input common mode range	-	0.1	-	V_{DD}-1.2	V
DC gain	-	-	70	-	dB
Propagation delay	@VCM=1.2 V and VDIFF=0.1 V	-	200	-	ns
Comparison voltage	20 mV@VCM=1 V 50 mV@VCM=0.1 V 50 mV@VCM=V_{DD}-1.2 @10 mV for non-hysteresis	10	20	-	mV
Hysteresis	One bit control W/O and W. hysteresis @VCM=0.4 V ~ V_{DD}-1.2 V	-	±10	-	mV
Wake-up time	@CINP=1.3 V CINN=1.2 V	-	-	2	us

8.3 48L LQFP (7x7x1.4mm footprint 2.0mm)



Controlling dimension : Millimeters

Symbol	Dimension in inch			Dimension in mm		
	Min	Nom	Max	Min	Nom	Max
A	—	—	—	—	—	—
A_1	0.002	0.004	0.006	0.05	0.10	0.15
A_2	0.053	0.055	0.057	1.35	1.40	1.45
b	0.006	0.008	0.010	0.15	0.20	0.25
c	0.004	0.006	0.008	0.10	0.15	0.20
D	0.272	0.276	0.280	6.90	7.00	7.10
E	0.272	0.276	0.280	6.90	7.00	7.10
e	0.014	0.020	0.026	0.35	0.50	0.65
H_D	0.350	0.354	0.358	8.90	9.00	9.10
H_E	0.350	0.354	0.358	8.90	9.00	9.10
L	0.018	0.024	0.030	0.45	0.60	0.75
L_1	—	0.039	—	—	1.00	—
Y	—	—	0.004	—	—	0.10
θ	0°	—	7 °	0°	—	7 °

9 REVISION HISTORY

VERSION	DATE	PAGE/ CHAP.	DESCRIPTION
V1.00	March 1, 2010	-	Preliminary version initial issued
V1.01	April 9, 2010	Ch4	Modify the block diagram
V1.02	May 31, 2010	7.2	Add operation current of DC characteristics
V1.03	Aug. 23, 2010	7.2	Modify operation current of DC characteristics
V2.00	Nov. 11, 2010	-	Update low density and selection table
V3.00	May 6, 2011	All	Revise from NUC140XXXAN or NUC140XXXBN to NUC140XXXCN Revise NUC140 selection guide Revise Functional Description Revise DC Electrical Characteristics
V3.01	June 22, 2011	-	modify temperature sensor spec Revise Pin description position for multi-function T2EX, T3EX, nRD, nWR update title of SPI Dynamic Characteristics update BOD spec
V3.02	Jan. 2, 2012	-	1. Remove feature “Dynamic priority changing” for NVIC 2. Modify ADC analog characteristic spec 3. Remove SPI FIFO mode